

TrenchP™ Power MOSFETs

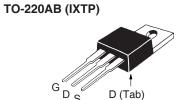
P-Channel Enhancement Mode Avalanche Rated

IXTA32P20T IXTP32P20T IXTQ32P20T IXTH32P20T

- 200V - 32A $130 m\Omega$ $\mathbf{R}_{\mathrm{DS(on)}}$

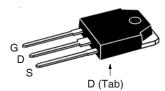
TO-263 AA (IXTA)







TO-3P	(IXTQ)
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Symbol	Test Conditions	Maximum F	Maximum Ratings		
V _{DSS}	$T_{_{\rm J}}$ = 25°C to 150°C	- 200	V		
V _{DGR}	$T_J = 25^{\circ}C$ to 150°C, $R_{GS} = 1M\Omega$	- 200	V		
V _{GSS}	Continuous	<u>+</u> 15	V		
V _{GSM}	Transient	<u>+</u> 25	V		
I _{D25}	T _C = 25°C	- 32	Α		
I _{DM}	$T_{\rm C} = 25^{\circ}$ C, Pulse Width Limited by $T_{\rm JM}$	- 96	Α		
I _A	T _c = 25°C	- 32	A		
E _{AS}	$T_{c} = 25^{\circ}C$	1	J		
P_{D}	T _C = 25°C	300	W		
T _J		-55 +150	°C		
T _{.IM}		150	°C		
T _{stg}		-55 +150	°C		
T,	1.6mm (0.062 in.) from Case for 10s	300	°C		
T _{SOLD}	Plastic body for 10s	260	°C		
F _c	Mounting Force (TO-263)	1065 / 2.214.6	N/lb.		
M _d	Mounting Torque (TO-220, TO-247 & TO	9-3P) 1.13 / 10	Nm/lb.in.		
Weight	TO-263	2.5	g		
	TO-220	3.0	g		
	TO-3P	5.5	g		
	TO-247	6.0	9		

* DSS	1 _J = 23 3 13 133 3		•
V _{DGR}	$T_{_{\rm J}} = 25^{\circ}\text{C} \text{ to } 150^{\circ}\text{C}, R_{_{\rm GS}} = 1\text{M}\Omega$	- 200	V
V _{GSS}	Continuous	<u>+</u> 15	V
V _{GSM}	Transient	<u>+</u> 25	V
I _{D25}	T _c = 25°C	- 32	A
I _{DM}	$T_{c} = 25$ °C, Pulse Width Limited by T_{JM}	- 96	Α
I _A	T _c = 25°C	- 32	Α
E _{AS}	$T_c = 25^{\circ}C$	1	J
$\mathbf{P}_{\scriptscriptstyle \mathrm{D}}$	T _C = 25°C	300	W
T		-55 +150	°C
T _{JM}		150	°C
T _{stg}		-55 +150	°C
T,	1.6mm (0.062 in.) from Case for 10s	300	°C
T _{SOLD}	Plastic body for 10s	260	°C
F _c	Mounting Force (TO-263) 106	65 / 2.214.6	N/lb.
M _d	Mounting Torque (TO-220, TO-247 & TO-3P)	1.13 / 10	Nm/lb.in.
Weight	TO-263	2.5	g
	TO-220	3.0	g
	TO-3P	5.5	g
	TO-247	6.0	g

TO-247 (IXTH)	
G_	
D S	D (Tab)

G = Gate	D	= Drain
S = Source	Tab	= Drain

Features

- International Standard Packages
- Avalanche Rated
- Extended FBSOA
- Fast Intrinsic Diode
- Low R_{DS(ON)} and Q_G

Advantages

- Easy to Mount
- Space Savings
- High Power Density

Applications

- High-Side Switching
- Push Pull Amplifiers
- DC Choppers
- Automatic Test Equipment
- Current Regulators
- Battery Charger Applications

		cteristic Values Typ. Max.			
BV _{DSS}	$V_{GS} = 0V, I_{D} = -250\mu A$	- 200			V
V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250\mu A$	- 2.0		- 4.0	V
I _{GSS}	$V_{GS} = \pm 15V, V_{DS} = 0V$			±100	nA
I _{DSS}	$V_{DS} = V_{DSS}$, $V_{GS} = 0V$ $T_{J} = 125^{\circ}C$			- 25 -1.25	μA mA
R _{DS(on)}	$V_{GS} = -10V, I_{D} = 0.5 \bullet I_{D25}, Note 1$			130	mΩ



Symbol (T _J = 25°C,	Test Conditions Unless Otherwise Specified)	Charac Min.	teristic \ Typ.	Values Max.
g _{fs}	$V_{DS} = -10V, I_{D} = 0.5 \bullet I_{D25}, \text{ Note 1}$	18	30	S
C _{iss}			14.5	nF
C _{oss}	$V_{GS} = 0V, V_{DS} = -25V, f = 1MHz$		565	pF
C _{rss}			105	pF
t _{d(on)}	Resistive Switching Times		32	ns
t _r	•		15	ns
t _{d(off)}	$V_{GS} = -10V, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 0.5 \cdot I_{D25}$		57	ns
t,	$R_{_{G}} = 1\Omega \text{ (External)}$		12	ns
$Q_{g(on)}$			185	nC
Q _{gs}	$V_{GS} = -10V$, $V_{DS} = 0.5 \cdot V_{DSS}$, $I_{D} = 0.5 \cdot I_{D25}$		66	nC
Q_{gd}			45	nC
R _{thJC}				0.42 °C/W
R _{thcs}	TO-220 TO-247 &TO-3P		0.50 0.21	°C/W °C/W

Source-Drain Diode

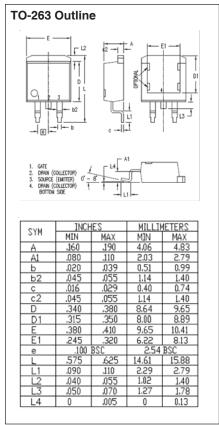
Note

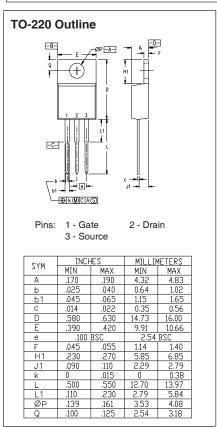
Symbol	Test Conditions	Characteristic Values			
$(T_{_{\rm J}} = 25^{\circ}\text{C}, \text{ Unless Otherwise Specified})$ Min		Min.	Тур.	Max.	
I _s	$V_{GS} = 0V$			- 32	Α
I _{SM}	Repetitive, Pulse Width Limited by $T_{_{\rm JM}}$			-128	Α
V _{SD}	$I_F = -32A, V_{GS} = 0V, Note 1$			-1.3	V
$\left\{egin{array}{c} \mathbf{t}_{rr} & \ \mathbf{Q}_{RM} \ \mathbf{I}_{RM} \end{array} ight. \right\}$	$I_{_{\rm F}}$ = -16A, -di/dt = -100A/ μ s $V_{_{\rm R}}$ = -100V, $V_{_{\rm GS}}$ = 0V		190 1.7 -17.8		ns µC A

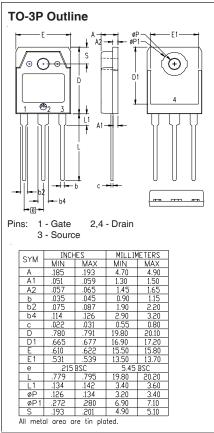
1: Pulse test, $t \le 300\mu s$, duty cycle, $d \le 2\%$.

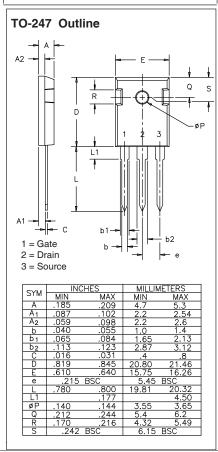


IXTA32P20T IXTQ32P20T IXTP32P20T IXTH32P20T











-5

0

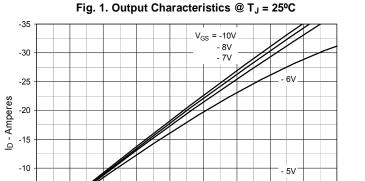


Fig. 2. Extended Output Characteristics @ $T_J = 25^{\circ}C$

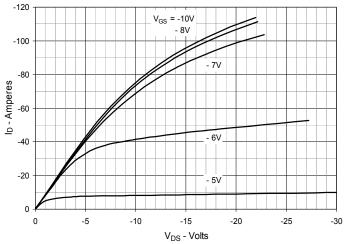


Fig. 3. Output Characteristics @ T_J = 125°C

V_{DS} - Volts

-2.5

-2

-1.5

4V

-3.5

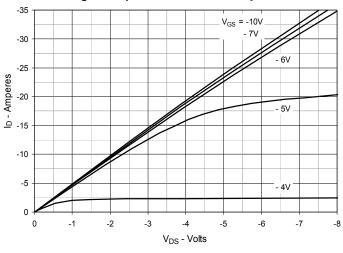


Fig. 4. $R_{DS(on)}$ Normalized to $I_D = -16A$ Value vs. Junction Temperature

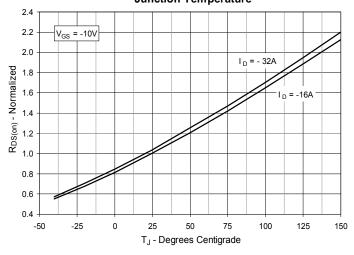


Fig. 5. $R_{DS(on)}$ Normalized to $I_D = -16A$ Value vs.

Drain Current

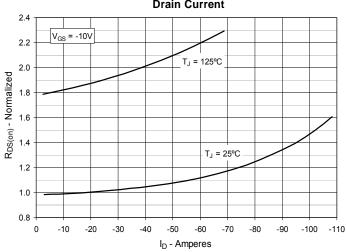
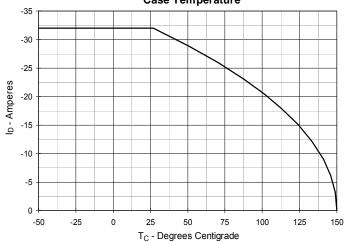


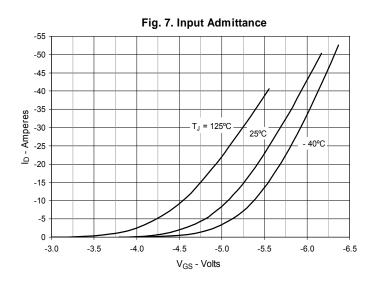
Fig. 6. Maximum Drain Current vs.

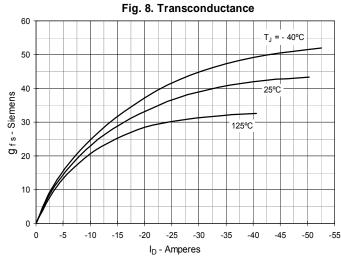
Case Temperature

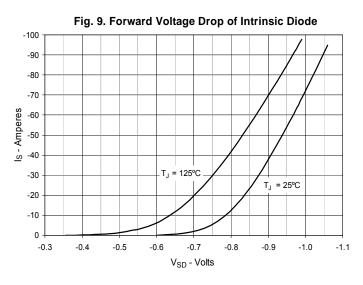


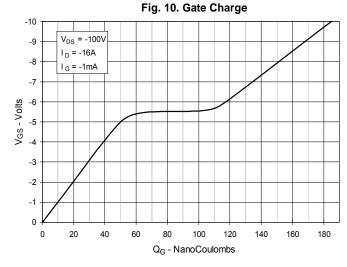
 $\ensuremath{\mathsf{IXYS}}$ Reserves the Right to Change Limits, Test Conditions, and Dimensions.

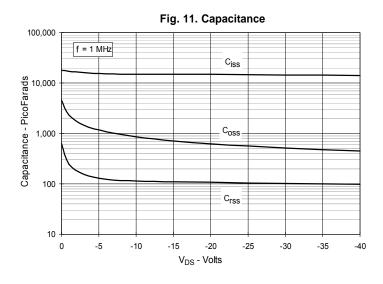












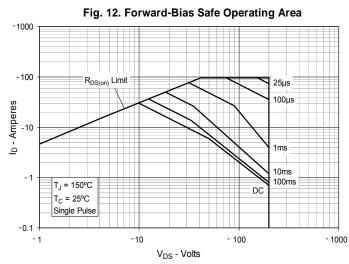




Fig. 13. Resistive Turn-on Rise Time vs.
Junction Temperature

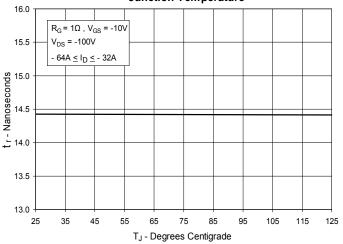


Fig. 14. Resistive Turn-on Rise Time vs.

Drain Current

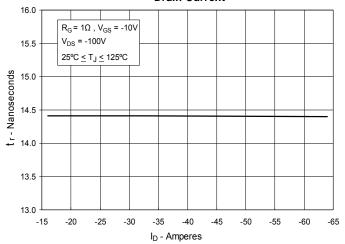


Fig. 15. Resistive Turn-on Switching Times vs.

Gate Resistance

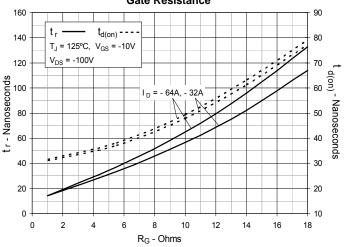


Fig. 16. Resistive Turn-off Switching Times vs.

Junction Temperature

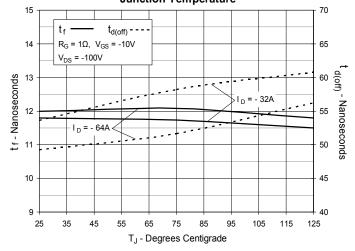


Fig. 17. Resistive Turn-off Switching Times vs.

Drain Current

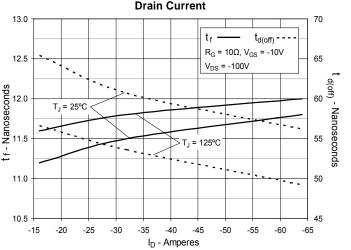
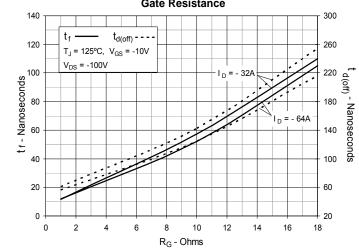
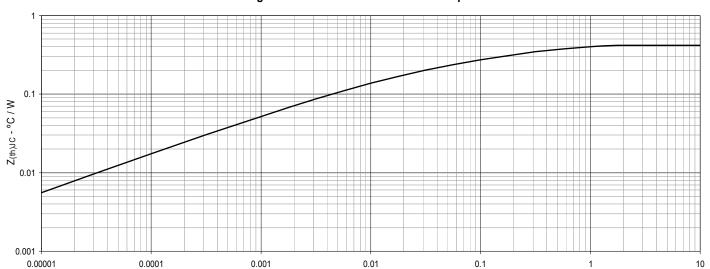


Fig. 18. Resistive Turn-off Switching Times vs.
Gate Resistance



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Pulse Width - Seconds

Fig. 19. Maximum Transient Thermal Impedance

